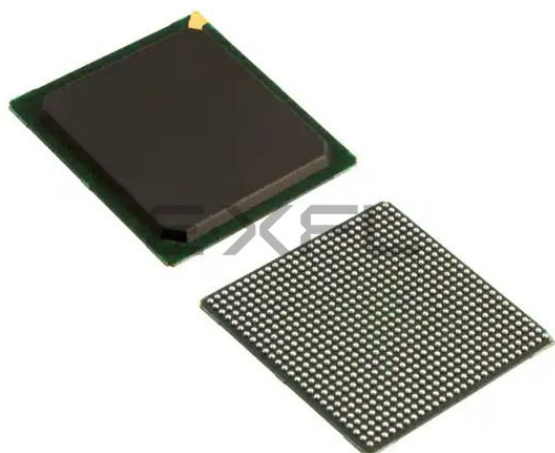




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Active
Number of LABs/CLBs	8064
Number of Logic Elements/Cells	-
Total RAM Bits	73728
Number of I/O	336
Number of Gates	500000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	676-BGA
Supplier Device Package	676-FBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/ax500-1fg676

I/O Banks and Compatibility

Since each I/O bank has its own user-assigned input reference voltage (VREF) and an input/output supply voltage (VCCI), only I/Os with compatible standards can be assigned to the same bank.

Table 2-11 shows the compatible I/O standards for a common VREF (for voltage-referenced standards). Similarly, Table 2-12 shows compatible standards for a common VCCI.

Table 2-11 • Compatible I/O Standards for Different VREF Values

VREF	Compatible Standards
1.5 V	SSTL 3 (Class I and II)
1.25 V	SSTL 2 (Class I and II)
1.0 V	GTL+ (2.5V and 3.3V Outputs)
0.75 V	HSTL (Class I)

Table 2-12 • Compatible I/O Standards for Different VCCI Values

VCCI ¹	Compatible Standards	VREF
3.3 V	LVTTL, PCI, PCI-X, LVPECL, GTL+ 3.3 V	1.0
3.3 V	SSTL 3 (Class I and II), LVTTL, PCI, LVPECL	1.5
2.5 V	LVC MOS 2.5 V, GTL+ 2.5 V, LVDS ²	1.0
2.5 V	LVC MOS 2.5 V, SSTL 2 (Classes I and II), LVDS ²	1.25
1.8 V	LVC MOS 1.8 V	N/A
1.5 V	LVC MOS 1.5 V, HSTL Class I	0.75

Notes:

1. VCCI is used for both inputs and outputs
2. VCCI tolerance is $\pm 5\%$

Table 2-22 • 3.3 V LVTTTL I/O Module

Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0 V, T_J = 70°C (continued)

		–2 Speed		–1 Speed		Std Speed		
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Units
LVTTTL Output Drive Strength = 2 (12 mA) / High Slew Rate								
t _{DP}	Input Buffer		1.68		1.92		2.26	ns
t _{PY}	Output Buffer		3.30		3.76		4.42	ns
t _{ENZL}	Enable to Pad Delay through the Output Buffer—Z to Low		3.74		4.26		5.00	ns
t _{ENZH}	Enable to Pad Delay through the Output Buffer—Z to High		3.06		3.49		4.10	ns
t _{ENLZ}	Enable to Pad Delay through the Output Buffer—Low to Z		1.89		1.91		1.91	ns
t _{ENHZ}	Enable to Pad Delay through the Output Buffer—High to Z		2.29		2.30		2.31	ns
t _{IOCLKQ}	Sequential Clock-to-Q for the I/O Input Register		0.67		0.77		0.90	ns
t _{IOCLKY}	Clock-to-output Y for the I/O Output Register and the I/O Enable Register		0.67		0.77		0.90	ns
t _{SUD}	Data Input Set-Up		0.23		0.27		0.31	ns
t _{SUE}	Enable Input Set-Up		0.26		0.30		0.35	ns
t _{HD}	Data Input Hold		0.00		0.00		0.00	ns
t _{HE}	Enable Input Hold		0.00		0.00		0.00	ns
t _{CPWHL}	Clock Pulse Width High to Low	0.39		0.39		0.39		ns
t _{CPWLH}	Clock Pulse Width Low to High	0.39		0.39		0.39		ns
t _{WASYN}	Asynchronous Pulse Width	0.37		0.37		0.37		ns
t _{REASYN}	Asynchronous Recovery Time		0.13		0.15		0.17	ns
t _{HASYN}	Asynchronous Removal Time		0.00		0.00		0.00	ns
t _{CLR}	Asynchronous Clear-to-Q		0.23		0.27		0.31	ns
t _{PRESET}	Asynchronous Preset-to-Q		0.23		0.27		0.31	ns

Timing Characteristics

Table 2-28 • 1.8V LVCMOS I/O Module

Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 1.7 V, TJ = 70°C

		–2 Speed		–1 Speed		Std Speed		
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Units
LVCMOS18 Output Module Timing								
t _{DP}	Input Buffer		3.26		3.71		4.37	ns
t _{PY}	Output Buffer		4.55		5.18		6.09	ns
t _{ENZL}	Enable to Pad Delay through the Output Buffer—Z to Low		2.82		2.83		2.84	ns
t _{ENZH}	Enable to Pad Delay through the Output Buffer—Z to High		3.43		3.45		3.46	ns
t _{ENLZ}	Enable to Pad Delay through the Output Buffer—Low to Z		6.01		6.85		8.05	ns
t _{ENHZ}	Enable to Pad Delay through the Output Buffer—High to Z		6.73		7.67		9.01	ns
t _{IOCLKQ}	Sequential Clock-to-Q for the I/O Input Register		0.67		0.77		0.90	ns
t _{IOCLKY}	Clock-to-output Y for the I/O Output Register and the I/O Enable Register		0.67		0.77		0.90	ns
t _{SUD}	Data Input Set-Up		0.23		0.27		0.31	ns
t _{SUE}	Enable Input Set-Up		0.26		0.30		0.35	ns
t _{HD}	Data Input Hold		0.00		0.00		0.00	ns
t _{HE}	Enable Input Hold		0.00		0.00		0.00	ns
t _{CPWHL}	Clock Pulse Width High to Low	0.39		0.39		0.39		ns
t _{CPWLH}	Clock Pulse Width Low to High	0.39		0.39		0.39		ns
t _{WASYN}	Asynchronous Pulse Width	0.37		0.37		0.37		ns
t _{REASYN}	Asynchronous Recovery Time		0.13		0.15		0.17	ns
t _{HASYN}	Asynchronous Removal Time		0.00		0.00		0.00	ns
t _{CLR}	Asynchronous Clear-to-Q		0.23		0.27		0.31	ns
t _{PRESET}	Asynchronous Preset-to-Q		0.23		0.27		0.31	ns

Class II

Table 2-53 • DC Input and Output Levels

VIL		VIH		VOL	VOH	IOL	IOH
Min., V	Max., V	Min., V	Max., V	Max., V	Min., V	mA	mA
-0.3	VREF – 0.2	VREF + 0.2	3.6	VREF – 0.8	VREF + 0.8	16	–16

AC Loadings

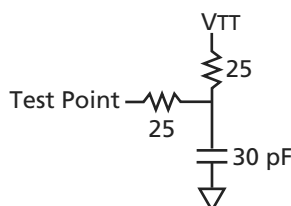


Figure 2-24 • AC Test Loads

Table 2-54 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ) (V)	C _{load} (pF)
VREF – 1.0	VREF + 1.0	VREF	1.50	30

Note: * Measuring Point = VTRIP

Timing Characteristics

Table 2-55 • 3.3 V SSTL3 Class II I/O Module

Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0V, T_J = 70°C

		–2 Speed		–1 Speed		Std Speed		
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Units
3.3 V SSTL3 Class II I/O Module Timing								
t _{DP}	Input Buffer		1.85		2.10		2.47	ns
t _{PY}	Output Buffer		2.17		2.47		2.91	ns
t _{CLKQ}	Clock-to-Q for the I/O input register		0.67		0.77		0.90	ns
t _{OCLKQ}	Clock-to-Q for the I/O output register and the I/O enable register		0.67		0.77		0.90	ns
t _{SUD}	Data Input Set-Up		0.23		0.27		0.31	ns
t _{SUE}	Enable Input Set-Up		0.26		0.30		0.35	ns
t _{HD}	Data Input Hold		0.00		0.00		0.00	ns
t _{HE}	Enable Input Hold		0.00		0.00		0.00	ns
t _{CPWHL}	Clock Pulse Width High to Low	0.39		0.39		0.39		ns
t _{CPWLH}	Clock Pulse Width Low to High	0.39		0.39		0.39		ns
t _{WASYN}	Asynchronous Pulse Width	0.37		0.37		0.37		ns
t _{REASYN}	Asynchronous Recovery Time		0.13		0.15		0.17	ns
t _{HASYN}	Asynchronous Removal Time		0.00		0.00		0.00	ns
t _{CLR}	Asynchronous Clear-to-Q		0.23		0.27		0.31	ns
t _{PRESET}	Asynchronous Preset-to-Q		0.23		0.27		0.31	ns

Table 2-57 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)
1.2 – 0.125	1.2 + 0.125	1.2

Note: * Measuring Point = VTRIP

Timing Characteristics

Table 2-58 • LVDS I/O Module

Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 2.3 V, T_J = 70°C

		–2 Speed		–1 Speed		Std Speed		Units
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	
LVDS Output Module Timing								
t _{DP}	Input Buffer		1.80		2.05		2.41	ns
t _{PY}	Output Buffer		2.32		2.64		3.11	ns
t _{CLKQ}	Clock-to-Q for the I/O input register		0.67		0.77		0.90	ns
t _{OCLKQ}	Clock-to-Q for the I/O output register and the I/O enable register		0.67		0.77		0.90	ns
t _{SUD}	Data Input Set-Up		0.23		0.27		0.31	ns
t _{SUE}	Enable Input Set-Up		0.26		0.30		0.35	ns
t _{HD}	Data Input Hold		0.00		0.00		0.00	ns
t _{HE}	Enable Input Hold		0.00		0.00		0.00	ns
t _{CPWHL}	Clock Pulse Width High to Low	0.39		0.39		0.39		ns
t _{CPWLH}	Clock Pulse Width Low to High	0.39		0.39		0.39		ns
t _{WASYN}	Asynchronous Pulse Width	0.37		0.37		0.37		ns
t _{REASYN}	Asynchronous Recovery Time		0.13		0.15		0.17	ns
t _{HASYN}	Asynchronous Removal Time		0.00		0.00		0.00	ns
t _{CLR}	Asynchronous Clear-to-Q		0.23		0.27		0.31	ns
t _{PRESET}	Asynchronous Preset-to-Q		0.23		0.27		0.31	ns

PLL Configurations

The following rules apply to the different PLL inputs and outputs:

Reference Clock

The RefCLK can be driven by (Figure 2-50):

1. Global routed clocks (CLKE/F/G/H) or user-created clock network
2. CLK1 output of an adjacent PLL
3. [H]CLKxP (single-ended or voltage-referenced)
4. [H]CLKxP/[H]CLKxN pair (differential modes like LVPECL or LVDS)

Feedback Clock

The feedback clock can be driven by (Figure 2-51 on page 2-78):

1. Global routed clocks (CLKE/F/G/H) or user-created clock network
2. External [H]CLKxP/N I/O pad(s) from the adjacent PLL cell
3. An internal signal from the PLL block

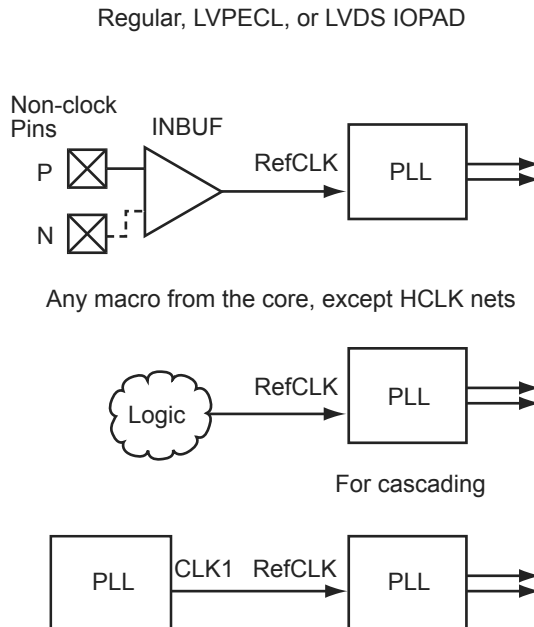


Figure 2-50 • Reference Clock Connections

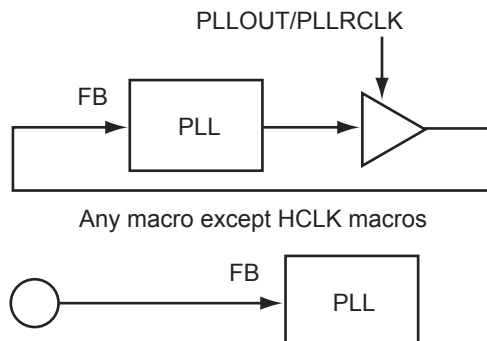


Figure 2-51 • Feedback Clock Connections

Note that the RAM blocks employ little-endian byte order for read and write operations.

Table 2-88 • RAM Signal Description

Signal	Direction	Description
WCLK	Input	Write clock (can be active on either edge).
WA[J:0]	Input	Write address bus. The value J is dependent on the RAM configuration and the number of cascaded memory blocks. The valid range for J is from 6 to 15.
WD[M-1:0]	Input	Write data bus. The value M is dependent on the RAM configuration and can be 1, 2, 4, 9, 18, or 36.
RCLK	Input	Read clock (can be active on either edge).
RA[K:0]	Input	Read address bus. The value K is dependent on the RAM configuration and the number of cascaded memory blocks. The valid range for K is from 6 to 15.
RD[N-1:0]	Output	Read data bus. The value N is dependent on the RAM configuration and can be 1, 2, 4, 9, 18, or 36.
REN	Input	Read enable. When this signal is valid on the active edge of the clock, data at location RA will be driven onto RD.
WEN	Input	Write enable. When this signal is valid on the active edge of the clock, WD data will be written at location WA.
RW[2:0]	Input	Width of the read operation dataword.
WW[2:0]	Input	Width of the write operation dataword.
Pipe	Input	Sets the pipe option to be on or off.

Modes of Operation

There are two read modes and one write mode:

- Read Nonpipelined (synchronous – one clock edge)
- Read Pipelined (synchronous – two clock edges)
- Write (synchronous – one clock edge)

In the standard read mode, new data is driven onto the RD bus in the clock cycle immediately following RA and REN valid. The read address is registered on the read-port active-clock edge and data appears at read-data after the RAM access time. Setting the PIPE to OFF enables this mode.

The pipelined mode incurs an additional clock delay from address to data, but enables operation at a much higher frequency. The read-address is registered on the read-port active-clock edge, and the read data is registered and appears at RD after the second read clock edge. Setting the PIPE to ON enables this mode.

On the write active-clock edge, the write data are written into the SRAM at the write address when WEN is high. The setup time of the write address, write enables, and write data are minimal with respect to the write clock.

Write and read transfers are described with timing requirements beginning in the "Timing Characteristics" section on page 2-89.

Table 2-89 • One RAM Block

Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0 V, T_J = 70°C

		–2 Speed		–1 Speed		Std Speed		Units
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	
Write Mode								
t _{WDASU}	Write Data Setup vs. WCLK		1.08		1.23		1.45	ns
t _{WDAHD}	Write Data Hold vs. WCLK		0.22		0.25		0.30	ns
t _{WADSU}	Write Address Setup vs. WCLK		1.08		1.23		1.45	ns
t _{WADHD}	Write Address Hold vs. WCLK		0.00		0.00		0.00	ns
t _{WENSU}	Write Enable Setup vs. WCLK		1.08		1.23		1.45	ns
t _{WENHD}	Write Enable Hold vs. WCLK		0.22		0.25		0.30	ns
t _{WCKH}	WCLK Minimum High Pulse Width	0.75		0.75		0.75		ns
t _{WCLK}	WCLK Minimum Low Pulse Width	0.88		0.88		0.88		ns
t _{WCKP}	WCLK Minimum Period	1.63		1.63		1.63		ns
Read Mode								
t _{RADSU}	Read Address Setup vs. RCLK		0.81		0.92		1.08	ns
t _{RADHD}	Read Address Hold vs. RCLK		0.00		0.00		0.00	ns
t _{RENSU}	Read Enable Setup vs. RCLK		0.81		0.92		1.08	ns
t _{RENHD}	Read Enable Hold vs. RCLK		0.00		0.00		0.00	ns
t _{RCK2RD1}	RCLK-to-OUT (Pipelined)		1.32		1.51		1.77	ns
t _{RCK2RD2}	RCLK-to-OUT (Non-Pipelined)		2.16		2.46		2.90	ns
t _{RCLKH}	RCLK Minimum High Pulse Width	0.77		0.77		0.77		ns
t _{RCLKL}	RCLK Minimum Low Pulse Width	0.93		0.93		0.93		ns
t _{RCKP}	RCLK Minimum Period	1.70		1.70		1.70		ns

Note: Timing data for this single block RAM has a depth of 4,096. For all other combinations, use Microsemi's timing software.

Table 2-91 • Four RAM Blocks Cascaded
Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0 V, T_J = 70°C

		–2 Speed		–1 Speed		Std Speed		
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Units
Write Mode								
t _{WDASU}	Write Data Setup vs. WCLK		2.37		2.70		3.17	ns
t _{WDAHD}	Write Data Hold vs. WCLK		0.00		0.00		0.00	ns
t _{WADSU}	Write Address Setup vs. WCLK		2.37		2.70		3.17	ns
t _{WADHD}	Write Address Hold vs. WCLK		0.00		0.00		0.00	ns
t _{WENSU}	Write Enable Setup vs. WCLK		2.37		2.70		3.17	ns
t _{WENHD}	Write Enable Hold vs. WCLK		0.00		0.00		0.00	ns
t _{WCKH}	WCLK Minimum High Pulse Width	0.75		0.75		0.75		ns
t _{WCLK}	WCLK Minimum Low Pulse Width	2.51		2.51		2.51		ns
t _{WCKP}	WCLK Minimum Period	3.26		3.26		3.26		ns
Read Mode								
t _{RADSU}	Read Address Setup vs. RCLK		3.08		3.51		4.13	ns
t _{RADHD}	Read Address Hold vs. RCLK		0.00		0.00		0.00	ns
t _{RENSU}	Read Enable Setup vs. RCLK		3.08		3.51		4.13	ns
t _{RENHD}	Read Enable Hold vs. RCLK		0.00		0.00		0.00	ns
t _{RCK2RD1}	RCLK-To-OUT (Pipelined)		2.36		2.69		3.16	ns
t _{RCK2RD2}	RCLK-To-OUT (Non-Pipelined)		2.83		3.23		3.79	ns
t _{RCLKH}	RCLK Minimum High Pulse Width	0.73		0.73		0.73		ns
t _{RCLKL}	RCLK Minimum Low Pulse Width	2.96		2.96		2.96		ns
t _{RCKP}	RCLK Minimum Period	3.69		3.69		3.69		ns

Note: Timing data for these four cascaded RAM blocks uses a depth of 16,384. For all other combinations, use Microsemi's timing software.

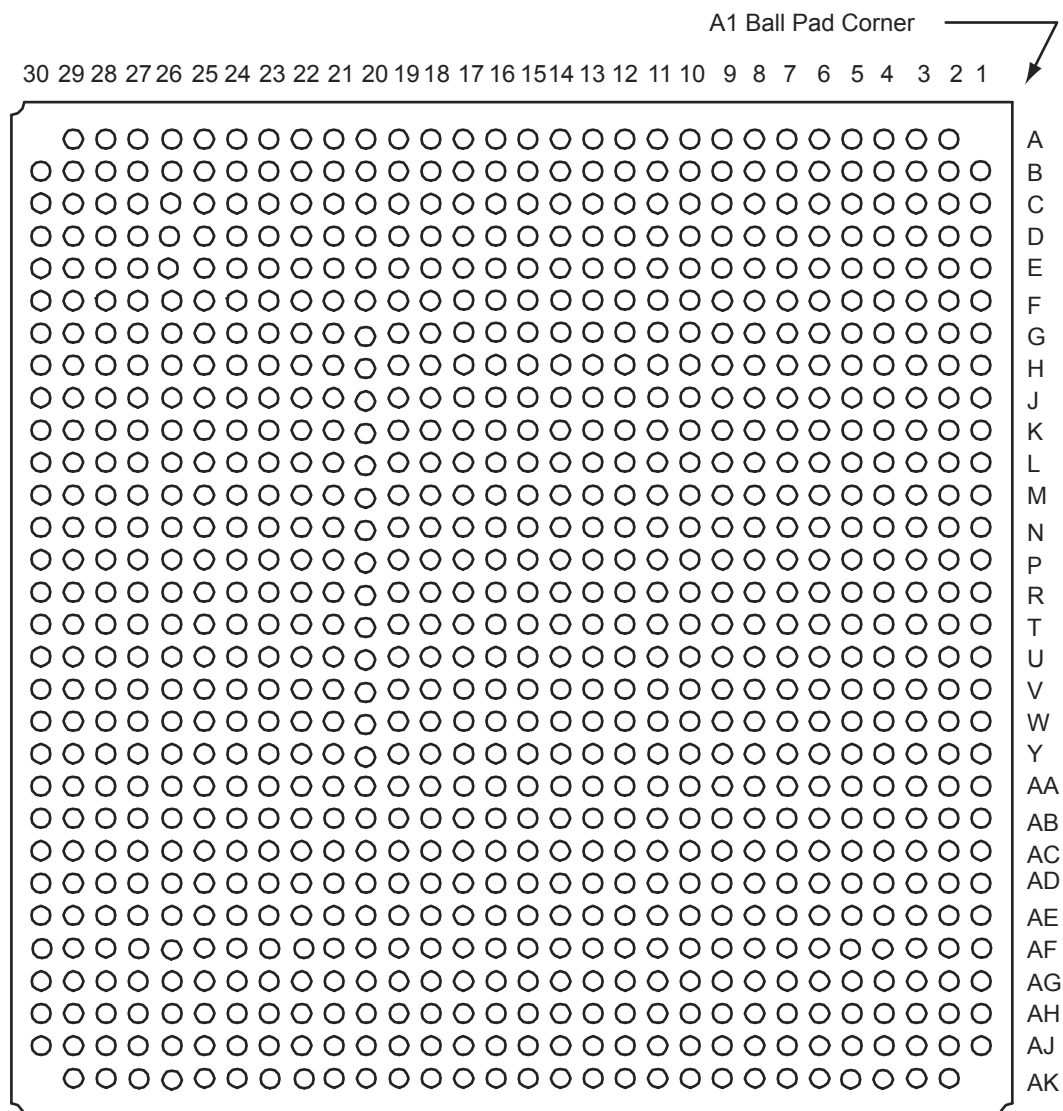
FG484		FG484		FG484	
AX1000 Function	Pin Number	AX1000 Function	Pin Number	AX1000 Function	Pin Number
IO246NB7F22	F3	GND	D4	GND	V5
IO246PB7F22	G3	GND	E18	GND	W19
IO250NB7F23	F4	GND	E5	GND	W4
IO250PB7F23	G4	GND	G18	GND	Y20
IO253NB7F23	G5	GND	H15	GND	Y3
IO253PB7F23	G6	GND	H8	GND/LP	G7
IO254NB7F23	D1	GND	J14	PRA	G11
IO254PB7F23	E1	GND	J9	PRB	F11
IO257NB7F23	F5	GND	K10	PRC	T12
IO257PB7F23	E4	GND	K11	PRD	U12
Dedicated I/O		GND	K12	TCK	G8
VCCDA	H7	GND	K13	TDI	F9
GND	A1	GND	L1	TDO	F7
GND	A11	GND	L10	TMS	F6
GND	A12	GND	L11	TRST	F8
GND	A2	GND	L12	VCCA	G17
GND	A21	GND	L13	VCCA	J10
GND	A22	GND	L22	VCCA	J11
GND	AA1	GND	M1	VCCA	J12
GND	AA2	GND	M10	VCCA	J13
GND	AA21	GND	M11	VCCA	J7
GND	AA22	GND	M12	VCCA	K14
GND	AB1	GND	M13	VCCA	K9
GND	AB11	GND	M22	VCCA	L14
GND	AB12	GND	N10	VCCA	L9
GND	AB2	GND	N11	VCCA	M14
GND	AB21	GND	N12	VCCA	M9
GND	AB22	GND	N13	VCCA	N14
GND	B1	GND	P14	VCCA	N9
GND	B2	GND	P9	VCCA	P10
GND	B21	GND	R15	VCCA	P11
GND	B22	GND	R8	VCCA	P12
GND	C20	GND	U16	VCCA	P13
GND	C3	GND	U6	VCCA	T6
GND	D19	GND	V18	VCCA	U17

FG676	
AX1000 Function	Pin Number
IO197PB6F18	Y6
IO198NB6F18	AD1
IO198PB6F18	AE1
IO199NB6F18	AA2
IO199PB6F18	AB2
IO200NB6F18	Y3
IO200PB6F18	AA3
IO201NB6F18	V5
IO201PB6F18	W5
IO202NB6F18	AB1
IO202PB6F18	AC1
IO203NB6F19	V4
IO203PB6F19	W4
IO204NB6F19	V3
IO204PB6F19	W3
IO205NB6F19	U6
IO205PB6F19	V6
IO206NB6F19	W2
IO206PB6F19	Y2
IO207NB6F19	U4
IO207PB6F19	U5
IO208NB6F19	Y1
IO208PB6F19	AA1
IO209NB6F19	T6
IO209PB6F19	T7
IO211NB6F19	T3
IO211PB6F19	U3
IO212NB6F19	V1
IO212PB6F19	V2
IO213NB6F19	T5
IO213PB6F19	T4
IO214NB6F20	U1
IO214PB6F20	U2
IO215NB6F20	R6
IO215PB6F20	R7
IO217NB6F20	R5

FG676	
AX1000 Function	Pin Number
IO217PB6F20	R4
IO218NB6F20	R2
IO218PB6F20	T2
IO219NB6F20	P3
IO219PB6F20	R3
IO220NB6F20	R1
IO220PB6F20	T1
IO221NB6F20	P6
IO221PB6F20	P7
IO223NB6F20	P5
IO223PB6F20	P4
Bank 7	
IO225NB7F21	N5
IO225PB7F21	N4
IO226NB7F21	N2
IO226PB7F21	N3
IO227NB7F21	N6
IO227PB7F21	N7
IO229NB7F21	M7
IO229PB7F21	M6
IO231NB7F21	M5
IO231PB7F21	M4
IO232NB7F21	L1
IO232PB7F21	M1
IO233NB7F21	M2
IO233PB7F21	M3
IO235NB7F21	K2
IO235PB7F21	L2
IO236NB7F22	L5
IO236PB7F22	L4
IO237NB7F22	L6
IO237PB7F22	L7
IO238NB7F22	K3
IO238PB7F22	L3
IO240NB7F22	J1
IO240PB7F22	K1

FG676	
AX1000 Function	Pin Number
IO241NB7F22	K6
IO241PB7F22	K5
IO242NB7F22	H2
IO242PB7F22	J2
IO243NB7F22	J4
IO243PB7F22	K4
IO244NB7F22	H3
IO244PB7F22	J3
IO245NB7F22	G2
IO245PB7F22	G1
IO247NB7F23	J6
IO247PB7F23	J5
IO248NB7F23	E1
IO248PB7F23	F1
IO249NB7F23	E2
IO249PB7F23	F2
IO250NB7F23	G4
IO250PB7F23	H4
IO251NB7F23	F3
IO251PB7F23	G3
IO253NB7F23	H6
IO253PB7F23	H5
IO254NB7F23	D2
IO254PB7F23	D1
IO255NB7F23	E4
IO255PB7F23	F4
IO256NB7F23	D3
IO256PB7F23	E3
IO257NB7F23	F5
IO257PB7F23	G5
Dedicated I/O	
GND	A1
GND	A13
GND	A14
GND	A19
GND	A26

FG896



Note

For Package Manufacturing and Environmental information, visit Resource center at <http://www.microsemi.com/soc/products/rescenter/package/index.html>.

FG896	
AX1000 Function	Pin Number
GND	A13
GND	A18
GND	A2
GND	A23
GND	A29
GND	A8
GND	AA10
GND	AA21
GND	AA28
GND	AA3
GND	AB2
GND	AB22
GND	AB29
GND	AB9
GND	AC1
GND	AC30
GND	AE25
GND	AE6
GND	AF26
GND	AF5
GND	AG27
GND	AG4
GND	AH10
GND	AH15
GND	AH16
GND	AH21
GND	AH28
GND	AH3
GND	AJ1
GND	AJ2
GND	AJ22
GND	AJ29
GND	AJ30
GND	AJ9
GND	AK13

FG896	
AX1000 Function	Pin Number
GND	AK18
GND	AK2
GND	AK23
GND	AK29
GND	AK8
GND	B1
GND	B2
GND	B22
GND	B29
GND	B30
GND	B9
GND	C10
GND	C15
GND	C16
GND	C21
GND	C28
GND	C3
GND	D27
GND	D28
GND	D4
GND	E26
GND	E5
GND	H1
GND	H30
GND	J2
GND	J22
GND	J29
GND	J9
GND	K10
GND	K21
GND	K28
GND	K3
GND	L11
GND	L20
GND	M12

FG896	
AX1000 Function	Pin Number
GND	M13
GND	M14
GND	M15
GND	M16
GND	M17
GND	M18
GND	M19
GND	N1
GND	N12
GND	N13
GND	N14
GND	N15
GND	N16
GND	N17
GND	N18
GND	N19
GND	N30
GND	P12
GND	P13
GND	P14
GND	P15
GND	P16
GND	P17
GND	P18
GND	P19
GND	R12
GND	R13
GND	R14
GND	R15
GND	R16
GND	R17
GND	R18
GND	R19
GND	R28
GND	R3

FG896	
AX2000 Function	Pin Number
VCCIB3	AH30
VCCIB3	T21
VCCIB3	U21
VCCIB3	V21
VCCIB3	W21
VCCIB3	W22
VCCIB3	Y21
VCCIB3	Y22
VCCIB4	AA16
VCCIB4	AA17
VCCIB4	AA18
VCCIB4	AA19
VCCIB4	AA20
VCCIB4	AB19
VCCIB4	AB20
VCCIB4	AB21
VCCIB4	AJ28
VCCIB4	AK28
VCCIB5	AA11
VCCIB5	AA12
VCCIB5	AA13
VCCIB5	AA14
VCCIB5	AA15
VCCIB5	AB10
VCCIB5	AB11
VCCIB5	AB12
VCCIB5	AJ3
VCCIB5	AK3
VCCIB6	AA9
VCCIB6	AH1
VCCIB6	AH2
VCCIB6	T10
VCCIB6	U10
VCCIB6	V10
VCCIB6	W10

FG896	
AX2000 Function	Pin Number
VCCIB6	W9
VCCIB6	Y10
VCCIB6	Y9
VCCIB7	C1
VCCIB7	C2
VCCIB7	K9
VCCIB7	L10
VCCIB7	L9
VCCIB7	M10
VCCIB7	M9
VCCIB7	N10
VCCIB7	P10
VCCIB7	R10
VCCPLA	G14
VCCPLB	H15
VCCPLC	G17
VCCPLD	J16
VCCPLE	AH17
VCCPLF	AC16
VCCPLG	AH14
VCCPLH	AD15
VCOMPLA	F14
VCOMPLB	J15
VCOMPLC	F17
VCOMPLD	H16
VCOMPLE	AF17
VCOMPLF	AD16
VCOMPLG	AF14
VCOMPLH	AB15
VPUMP	G24

CQ256	
AX2000 Function	Pin Number
Bank 0	
IO01NB0F0	248
IO01PB0F0	249
IO04NB0F0	246
IO04PB0F0	247
IO05NB0F0	242
IO05PB0F0	243
IO08NB0F0	240
IO08PB0F0	241
Bank 0	
IO37NB0F3	234
IO37PB0F3	235
IO41NB0F3/HCLKAN	232
IO41PB0F3/HCLKAP	233
IO42NB0F3/HCLKBN	228
IO42PB0F3/HCLKBP	229
Bank 1 -	
IO43NB1F4/HCLKCN	220
IO43PB1F4/HCLKCP	221
IO44NB1F4/HCLKDN	216
IO44PB1F4/HCLKDP	217
Bank 1	
IO65NB1F6	210
IO65PB1F6	211
IO69NB1F6	208
IO69PB1F6	209
IO70NB1F6	199
IO71NB1F6	204
IO71PB1F6	205
IO73NB1F6	202
IO73PB1F6	203
IO74NB1F6	197
IO74PB1F6	198
Bank 2	
IO87NB2F8	187

CQ256	
AX2000 Function	Pin Number
IO87PB2F8	188
IO89PB2F8	186
Bank 2	
IO107NB2F10	184
IO107PB2F10	185
IO110NB2F10	180
IO110PB2F10	181
IO111NB2F10	178
IO111PB2F10	179
IO112NB2F10	174
IO112PB2F10	175
IO113NB2F10	172
IO113PB2F10	173
IO114NB2F10	168
IO114PB2F10	169
IO115NB2F10	166
IO115PB2F10	167
IO117NB2F10	162
IO117PB2F10	163
Bank 3	
IO139NB3F13	158
IO139PB3F13	159
IO141NB3F13	154
IO141PB3F13	155
IO142NB3F13	152
IO142PB3F13	153
IO145NB3F13	148
IO145PB3F13	149
IO146NB3F13	146
IO146PB3F13	147
IO147NB3F13	140
IO147PB3F13	141
IO148NB3F13	142
IO148PB3F13	143
IO149NB3F13	136

CQ256	
AX2000 Function	Pin Number
IO149PB3F13	137
Bank 3	
IO165NB3F15	135
IO167NB3F15	133
IO167PB3F15	134
Bank 4	
IO181NB4F17	124
IO181PB4F17	125
IO182NB4F17	122
IO182PB4F17	123
IO183NB4F17	118
IO183PB4F17	119
IO184NB4F17	116
IO184PB4F17	117
IO190NB4F17	112
IO190PB4F17	113
IO192NB4F17	110
IO192PB4F17	111
Bank 4	
IO212NB4F19/CLKEN	104
IO212PB4F19/CLKEP	105
IO213NB4F19/CLKFN	100
IO213PB4F19/CLKFP	101
Bank 5	
IO214NB5F20/CLKGN	92
IO214PB5F20/CLKGP	93
IO215NB5F20/CLKHN	88
IO215PB5F20/CLKHP	89
Bank 5	
IO236NB5F22	82
IO236PB5F22	83
IO238NB5F22	80
IO238PB5F22	81
IO240NB5F22	76
IO240PB5F22	77

CQ352		CQ352		CQ352	
AX1000 Function	Pin Number	AX1000 Function	Pin Number	AX1000 Function	Pin Number
GND	21	GND	240	VCCA	14
GND	27	GND	246	VCCA	32
GND	33	GND	252	VCCA	56
GND	39	GND	258	VCCA	74
GND	45	GND	264	VCCA	87
GND	51	GND	265	VCCA	102
GND	57	GND	274	VCCA	114
GND	63	GND	280	VCCA	150
GND	69	GND	286	VCCA	162
GND	75	GND	292	VCCA	175
GND	81	GND	298	VCCA	191
GND	88	GND	310	VCCA	209
GND	89	GND	322	VCCA	233
GND	97	GND	330	VCCA	251
GND	103	GND	334	VCCA	263
GND	109	GND	340	VCCA	279
GND	115	GND	345	VCCA	291
GND	121	GND	352	VCCA	329
GND	133	NC	91	VCCA	339
GND	145	NC	130	VCCDA	2
GND	151	NC	131	VCCDA	44
GND	157	NC	174	VCCDA	90
GND	163	NC	268	VCCDA	116
GND	169	NC	307	VCCDA	117
GND	176	NC	308	VCCDA	132
GND	177	PRA	312	VCCDA	148
GND	186	PRB	311	VCCDA	149
GND	192	PRC	135	VCCDA	178
GND	198	PRD	134	VCCDA	221
GND	204	TCK	349	VCCDA	266
GND	210	TDI	348	VCCDA	293
GND	216	TDO	347	VCCDA	294
GND	222	TMS	350	VCCDA	309
GND	228	TRST	351	VCCDA	327
GND	234	VCCA	3	VCCDA	328

CQ352	
AX2000 Function	Pin Number
VCCDA	346
VCCIB0	321
VCCIB0	333
VCCIB0	344
VCCIB1	273
VCCIB1	285
VCCIB1	297
VCCIB2	227
VCCIB2	239
VCCIB2	245
VCCIB2	257
VCCIB3	185
VCCIB3	197
VCCIB3	203
VCCIB3	215
VCCIB4	144
VCCIB4	156
VCCIB4	168
VCCIB5	96
VCCIB5	108
VCCIB5	120
VCCIB6	50
VCCIB6	62
VCCIB6	68
VCCIB6	80
VCCIB7	8
VCCIB7	20
VCCIB7	26
VCCIB7	38
VCCPLA	317
VCCPLB	315
VCCPLC	303
VCCPLD	301
VCCPLE	140
VCCPLF	138

CQ352	
AX2000 Function	Pin Number
VCCPLG	126
VCCPLH	124
VCOMPLA	318
VCOMPLB	316
VCOMPLC	304
VCOMPLD	302
VCOMPLE	141
VCOMPLF	139
VCOMPLG	127
VCOMPLH	125
VPUMP	267

CG624	
AX2000 Function	Pin Number
IO229PB5F21	AD10
IO230NB5F21	V11
IO233NB5F21	AD7
IO233PB5F21	AD8
IO234NB5F21	V9
IO234PB5F21	V10
IO236NB5F22	AC9
IO238NB5F22	W8
IO238PB5F22	W9
IO239NB5F22	AE4
IO239PB5F22	AE5
IO240NB5F22	AB9
IO242NB5F22	AA9
IO242PB5F22	Y9
IO243NB5F22	AD5
IO243PB5F22	AD6
IO244NB5F22	U8
IO246NB5F23	AB8
IO246PB5F23	AC8
IO247NB5F23	AB7
IO247PB5F23	AC7
IO250NB5F23	AA8
IO250PB5F23	Y8
IO251NB5F23	V8
IO251PB5F23	V7
IO252NB5F23	Y7
IO252PB5F23	W7
IO253NB5F23	AC5
IO253PB5F23	AC6
IO254NB5F23	Y6
IO254PB5F23	W6
IO256NB5F23	AB6*

Note: *Not routed on the same package layer and to adjacent LGA pads as its differential pair complement. Recommended to be used as a single-ended I/O.

CG624	
AX2000 Function	Pin Number
IO256PB5F23	AA6*
Bank 6	
IO257NB6F24	Y3
IO257PB6F24	AA3
IO258NB6F24	V3
IO258PB6F24	W3
IO259NB6F24	AA2
IO259PB6F24	AB2
IO260NB6F24	V6*
IO260PB6F24	W4*
IO262NB6F24	U4
IO262PB6F24	V4
IO263NB6F24	Y5
IO263PB6F24	W5
IO268NB6F25	U6
IO268PB6F25	U5
IO269PB6F25	U3
IO272NB6F25	T2
IO272PB6F25	U2
IO273NB6F25	W2
IO273PB6F25	Y2
IO274NB6F25	R6
IO274PB6F25	T6
IO275NB6F25	T7
IO275PB6F25	U7
IO277NB6F25	V2
IO278NB6F26	R4
IO278PB6F26	T4
IO279PB6F26	R3
IO280NB6F26	R5
IO281NB6F26	AA1
IO281PB6F26	AB1

Note: *Not routed on the same package layer and to adjacent LGA pads as its differential pair complement. Recommended to be used as a single-ended I/O.

CG624	
AX2000 Function	Pin Number
IO284NB6F26	R8
IO284PB6F26	T8
IO285NB6F26	W1
IO285PB6F26	Y1
IO286NB6F26	P2
IO286PB6F26	R2
IO287NB6F26	T1
IO287PB6F26	U1
IO288NB6F26	P5
IO290NB6F27	P6
IO291NB6F27	P1
IO291PB6F27	R1
IO292NB6F27	P7
IO292PB6F27	R7
IO293NB6F27	M1
IO293PB6F27	N1
IO294NB6F27	P8
IO296NB6F27	N3
IO296PB6F27	P3
IO298NB6F27	N4
IO298PB6F27	P4
IO299NB6F27	M2
IO299PB6F27	N2
Bank 7	
IO300NB7F28	P9*
IO300PB7F28	N6*
IO302NB7F28	M6
IO304NB7F28	N8
IO304PB7F28	N7
IO308NB7F28	M4
IO309NB7F28	L3
IO309PB7F28	M3

Note: *Not routed on the same package layer and to adjacent LGA pads as its differential pair complement. Recommended to be used as a single-ended I/O.

Revision	Changes	Page
Revision 3 (continued)	The timing characteristics tables from pages 2-26 to 2-60 were updated.	2-26 to 2-60
	The "Global Resources" section was updated.	2-66
	The timing characteristics tables from pages 2-102 to 2-103 were updated.	2-102 to 2-103
	The "PQ208", "FG256", and "FG324" tables are new.	3-9,3-16, 3-84